

24-CHARACTER 2-LINE DOT MATRIX LCD CONTROLLER DRIVER

■ GENERAL DESCRIPTION

The NJU6406B is a 1 Chip Dot Matrix LCD controller driver for up to 24-character 2-line display.

It contains voltage converter, microprocessor interface circuits, instruction decoder controller, character generator ROM/RAM and high voltage operation common and segment drivers.

The voltage converter generates about twofold voltage (10V or 6V) from single power supply (5V or 3V). Consequently, high-contrast display can be performed though the simple power supply circuits.

The microprocessor interface circuits which operate 2MHz frequency, can be connected directly to 4bit/8bit microprocessor.

The character generator consists of 9,600bits ROM and 64 bytes RAM. The standard version ROM is coded with 240 characters including capital and small letter fonts and some of Japanese fonts.

The high voltage operation 32-common and 60-segment drivers operate by 13.5V or 12V, and drives up to 24-character 2-line LCD panels which divided four common electrode blocks.

■ PACKAGE OUTLINE



NJU6406BC

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■ FEATURES

- 24-character 2-line Dot Matrix LCD Controller Driver
- 4/8 Bit Microprocessor Direct Interface
- Display Data RAM - 80 x 8 bits ; Maximum 24-character 2-line Display
- Character Generator ROM - 9,600 bits ; 240 Characters for 5 x 7 Dots
- Character Generator RAM - 64 x 8 bits ; 8 Patterns(5x7 Dots)
- Microprocessor can access to Display Data RAM and Character Generator RAM
- High Voltage LCD Driver ; 32-common / 60-segment
- Programmable Duty Ratio ;

1/16 Duty for 5x 7 Dots + Cursor, 1 Line
1/32 Duty for 5x 7 Dots + Cursor, 2 Lines

- Number of Maximum Display Characters

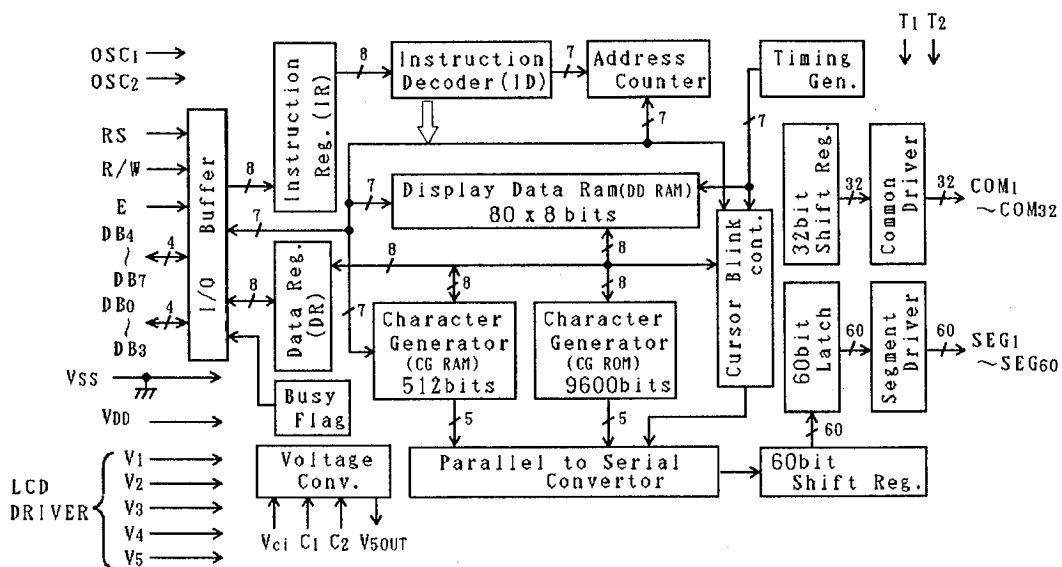
Display Line	Duty	Font	Max. Disp. Characters
1 Line	1/16 duty	5 x 7 dots + cursor	24-character 1-line
2 Lines	1/32 duty	5 x 7 dots + cursor	24-character 2-line

- Useful Instruction Set
Clear Display, Return Home, Display ON/OFF Cont, Cursor ON/OFF Cont, Display Blink, Cursor Shift, Character Shift
- Power On Initialize On-chip
- Voltage Converter On-chip
- Oscillation Circuit On-chip(External R or Ceramic Resonator required)
- Low Power Consumption
- Operating Voltage --- + 5 V / + 3 V
- Package Outline --- Chip / Bumped Chip / TCP
- C-MOS Technology

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Chip Size : X = 5.73mm , Y = 5.00mm
Chip Thickness : 400 μ m $\pm$ 30 μ m
Pad Size : 100 μ m $\times$ 100 μ m

BLOCK DIAGRAM



COORDINATES

Chip Size X = 5.73mm , Y = 5.00mm
Chip Thickness : 400um $\pm$ 30um

Chip Center : X = 0um, Y = 0um

No	Pad Name	X (um)	Y (um)	No	Pad Name	X (um)	Y (um)	No	Pad Name	X (um)	Y (um)
1	SEG ₄₅	-2320	-2275	41	V _{5OUT}	2640	- 720	81	SEG ₇	- 880	2275
2	SEG ₄₆	-2160	-2275	42	C ₁	2640	- 560	82	SEG ₈	-1040	2275
3	SEG ₄₇	-2000	-2275	43	C ₂	2640	- 400	83	SEG ₉	-1200	2275
4	SEG ₄₈	-1840	-2275	44	V _{ci}	2640	- 240	84	SEG ₁₀	-1360	2275
5	SEG ₄₉	-1680	-2275	45	V _{DD}	2640	- 80	85	SEG ₁₁	-1520	2275
6	SEG ₅₀	-1520	-2275	46	RS	2640	80	86	SEG ₁₂	-1680	2275
7	SEG ₅₁	-1360	-2275	47	R/W	2640	240	87	SEG ₁₃	-1840	2275
8	SEG ₅₂	-1200	-2275	48	E	2640	400	88	SEG ₁₄	-2000	2275
9	SEG ₅₃	-1040	-2275	49	DB ₀	2640	560	89	SEG ₁₅	-2160	2275
10	SEG ₅₄	- 880	-2275	50	DB ₁	2640	720	90	SEG ₁₆	-2320	2275
11	SEG ₅₅	- 720	-2275	51	DB ₂	2640	880	91	SEG ₁₇	-2640	2160
12	SEG ₅₆	- 560	-2275	52	DB ₃	2640	1040	92	SEG ₁₈	-2640	2000
13	SEG ₅₇	- 400	-2275	53	DB ₄	2640	1200	93	SEG ₁₉	-2640	1840
14	SEG ₅₈	- 240	-2275	54	DB ₅	2640	1360	94	SEG ₂₀	-2640	1680
15	SEG ₅₉	- 80	-2275	55	DB ₆	2640	1520	95	SEG ₂₁	-2640	1520
16	SEG ₆₀	80	-2275	56	DB ₇	2640	1680	96	SEG ₂₂	-2640	1360
17	COM ₉	240	-2275	57	T2	2640	1840	97	SEG ₂₃	-2640	1200
18	COM ₁₀	400	-2275	58	T1	2640	2000	98	SEG ₂₄	-2640	1040
19	COM ₁₁	560	-2275	59	COM ₂₄	2640	2275	99	SEG ₂₅	-2640	880
20	COM ₁₂	720	-2275	60	COM ₂₃	2480	2275	100	SEG ₂₆	-2640	720
21	COM ₁₃	880	-2275	61	COM ₂₂	2320	2275	101	SEG ₂₇	-2640	560
22	COM ₁₄	1040	-2275	62	COM ₂₁	2160	2275	102	SEG ₂₈	-2640	400
23	COM ₁₅	1200	-2275	63	COM ₂₀	2000	2275	103	SEG ₂₉	-2640	240
24	COM ₁₆	1360	-2275	64	COM ₁₉	1840	2275	104	SEG ₃₀	-2640	80
25	COM ₂₅	1520	-2275	65	COM ₁₈	1680	2275	105	SEG ₃₁	-2640	- 80
26	COM ₂₆	1680	-2275	66	COM ₁₇	1520	2275	106	SEG ₃₂	-2640	- 240
27	COM ₂₇	1840	-2275	67	COM ₈	1360	2275	107	SEG ₃₃	-2640	- 400
28	COM ₂₈	2000	-2275	68	COM ₇	1200	2275	108	SEG ₃₄	-2640	- 560
29	COM ₂₉	2160	-2275	69	COM ₆	1040	2275	109	SEG ₃₅	-2640	- 720
30	COM ₃₀	2320	-2275	70	COM ₅	880	2275	110	SEG ₃₆	-2640	- 880
31	COM ₃₁	2480	-2275	71	COM ₄	720	2275	111	SEG ₃₇	-2640	-1040
32	COM ₃₂	2640	-2275	72	COM ₃	560	2275	112	SEG ₃₈	-2640	-1200
33	V _{SS}	2640	-2000	73	COM ₂	400	2275	113	SEG ₃₉	-2640	-1360
34	OSC ₁	2640	-1840	74	COM ₁	240	2275	114	SEG ₄₀	-2640	-1520
35	OSC ₂	2640	-1680	75	SEG ₁	80	2275	115	SEG ₄₁	-2640	-1680
36	V ₁	2640	-1520	76	SEG ₂	- 80	2275	116	SEG ₄₂	-2640	-1840
37	V ₂	2640	-1360	77	SEG ₃	- 240	2275	117	SEG ₄₃	-2640	-2000
38	V ₃	2640	-1200	78	SEG ₄	- 400	2275	118	SEG ₄₄	-2640	-2160
39	V ₄	2640	-1040	79	SEG ₅	- 560	2275	-	--	-	-
40	V ₅	2640	- 880	80	SEG ₆	- 720	2275	-	--	-	-

■ TERMINAL DESCRIPTION

NO.	SYMBOL	F U N C T I O N
36~40	$V_1 \sim V_5$	LCD Driving Power Source
45	V_{DD}	Power Source (+ 5V / + 3V)
33	V_{SS}	Power Source (0V)
34,35	OSC ₁ , OSC ₂	Oscillation Terminals; External R or Ceramic Resonator connect to these terminals. For external clock operation, the clock should be input on OSC ₁ .
46	RS	Register selection signal input "0" : Instruction Register (Writing) Busy Flag (Reading) "1" : Data Register (Writing/Reading)
47	R/W	Read/Write selection signal input "0" : Write , "1" : Read
48	E	Read/Write activation signal input
53~56	DB ₄ ~DB ₇	3-state Data Bus(Upper) to transfer the data between MPU and NJU6406B DB ₇ is also used for the Busy Flag reading
49~52	DB ₀ ~DB ₃	3-state Data Bus(Lower) to transfer the data between MPU and NJU6406B These bus are not used in the 4bit operation
74~67 17~24 66~59 25~32	COM ₁ ~COM ₈ COM ₉ ~COM ₁₆ COM ₁₇ ~COM ₂₄ COM ₂₅ ~COM ₃₂	LCD Common driving signal No use terminals output no-active signal, or COM ₁₇ ~COM ₃₂ output no-active signal in the 1/16 duty operation.
75~118 1~16	SEG ₁ ~SEG ₄₄ SEG ₄₅ ~SEG ₆₀	LCD Segment driving signal
42,43	C_1 , C_2	Capacitor for Voltage Doubler Connecting Terminal { + } Capacitor for Voltage Doubler Connecting Terminal { - }
44	V_{ci}	Input Terminal for Voltage Doubler (Normally $V_{ci} = V_{DD}$)
41	V_{5out}	Voltage Doubler Output Terminal
58	T1	Maker Testing Terminal (Normally Open)
57	T2	Maker Testing Terminal (Normally Open)

FUNCTIONAL DESCRIPTION

(1) Description for each blocks

(1-1) Register

The NJU6406B incorporates two 8-bit registers, an Instruction Register(IR) and a Data Register(DR).

The Register(IR) stores instruction codes such as "Clear Display" and "Return Home", and address data for Display Data RAM (DD RAM) and Character Generator RAM(CG RAM). The MPU can write the instruction code and address data to the Register(IR), but it cannot read out from the Register(IR).

The Register (DR) is a temporary stored register, the data stored in the Register (DR) is written into the DD RAM or CG RAM and read out from the DD RAM or CG RAM.

The data in the Register(DR) written by the MPU is transferred automatically to the DD RAM or CG RAM by internal operation.

When the address data for the DD RAM or CG RAM is written into the Register(IR), the addressed data in the DD RAM or CG RAM is transferred to the Register(DR). By the MPU read out the data in the Register(DR), the data transmitting process is performed completely.

After reading the data in the Register(DR) by the MPU, the next address data in the DD RAM or CG RAM is transferred automatically to the Register(DR) to provide for the next MPU reading.

These two registers are selected by the selection signal RS as shown below:

Table 1. shows register operation controlled by RS and R/W signals.

Table 1. Register Operation

RS	R/W	Selected Register	Operation
0	0	IR	Write
0	1		Read busy flag(DB ₇) and address counter(DB ₀ ~DB ₆)
1	0	DR	Write (DR to DD or CG RAM)
1	1		Read (DD or CG RAM to DR)

(1-2) Busy Flag (BF)

When the internal circuits are in the operation mode, the busy flag is "1", and any instruction reading is inhibited.

The busy flag (BF) is output at DB₇ when RS="0" and R/W="1" as shown in table 1.

The next instruction should be written after busy flag (BF) goes to "0".

(1-3) Address Counter (AC)

The address Counter(AC) addressing the DD RAM and CG RAM.

When the address setting instruction is written into the Register(IR), the address information is transferred from Register(IR) to counter(AC). The selection of either the DD RAM or CG RAM is also determined by this instruction.

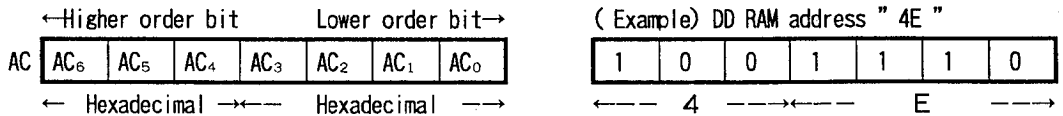
After writing (or reading) the display data to (or from) the DD RAM or CG RAM, the Counter (AC) increments (or decrements) automatically.

The address data in the Counter(AC) is output from DB₆~DB₀ when RS="0" and R/W="1" as shown in Table 1.

(1-4) Display Data RAM (DD RAM)

The display data RAM(DD RAM) consists of 80 x 8 bits, stores up to 80-character display data represented in 8-bit code.

The unused display data memory area in the DD RAM can be used as a general data memory area. The DD RAM address data set in the address Counter(AC) is represented in Hexadecimal.



(1-4-1) 1-line Display (Function set code N=0)

(a) 24-character 1-line Display Example

The relation between DD RAM address and display position on the LCD is shown below:

	1	2	3	4	5	6	7	8	9	10	11	12		19	20	21	22	23	24	←Display Position
1 Line	00	01	02	03	04	05	06	07	08	09	0A	0B	-----	12	13	14	15	16	17	←DD RAM Address (Hexadecimal)

When the display shift is performed, the DD RAM address changes as follows:

(Left Shift Display)

(00)←	01	02	03	04	05	06	07	08	09	0A	0B	0C	-----	13	14	15	16	17	18
-------	----	----	----	----	----	----	----	----	----	----	----	----	-------	----	----	----	----	----	----

(Right Shift Display)

4F	00	01	02	03	04	05	06	07	08	09	0A	-----	11	12	13	14	15	16	→(17)
----	----	----	----	----	----	----	----	----	----	----	----	-------	----	----	----	----	----	----	-------

(b) 20-character 1-line Display Example

The relation between DD RAM address and display position on the LCD is shown below:

	1	2	3	4	5	6	7	8	9	10	11	12		17	18	19	20	←Display Position
1 Line	00	01	02	03	04	05	06	07	08	09	0A	0B	-----	10	11	12	13	←DD RAM Address (Hexadecimal)

When the display shift is performed, the DD RAM address changes as follows:

(Left Shift Display)

(00)←	01	02	03	04	05	06	07	08	09	0A	0B	0C	-----	11	12	13	14
-------	----	----	----	----	----	----	----	----	----	----	----	----	-------	----	----	----	----

(Right Shift Display)

4F	00	01	02	03	04	05	06	07	08	09	0A	-----	0F	10	11	12	→(13)
----	----	----	----	----	----	----	----	----	----	----	----	-------	----	----	----	----	-------

The relation between DD RAM address and display position on the LCD is shown below:

When the display shift is performed, the DD RAM address changes as follows;

4F	00	01	02	03	04	05	06	07	08	09	0A
----	----	----	----	----	----	----	----	----	----	----	----

→ (0B)

The relation between DD RAM address and display position on the LCD is shown below:

Note : In the 2 lines display mode, the 1st line and 2nd address are defined as (00)_H to (27)_H and (40)_H to (67)_H. Please note that the end of 1st line address and the beginning of 2nd line address are not consecutive.

When the display shift is performed, the DD RAM address changes as follows:

27	00	01	02	03	04	05	06	07	08	09	0A	-----	11	12	13	14	15	16	→(17)
67	40	41	42	43	44	45	46	47	48	49	4A	-----	51	52	53	54	55	56	→(57)

(b) 20-character 2-line Display Example

The relation between DD RAM address and display position on the LCD is shown below:

	1	2	3	4	5	6	7	8	9	10	11	12		17	18	19	20	←Display Position
1st Line	00	01	02	03	04	05	06	07	08	09	0A	0B	-----	10	11	12	13	←
2nd Line	40	41	42	43	44	45	46	47	48	49	4A	4B	-----	50	51	52	53	← (Hexadecimal)

When the display shift is performed, the DD RAM address changes as follows:

(Left Shift Display)

(00)←	01	02	03	04	05	06	07	08	09	0A	0B	0C	-----	11	12	13	14
(40)←	41	42	43	44	45	46	47	48	49	4A	4B	4C	-----	51	52	53	54

(Right Shift Display)

27	00	01	02	03	04	05	06	07	08	09	0A	-----	0F	10	11	12	→(13)
67	40	41	42	43	44	45	46	47	48	49	4A	-----	4F	50	51	52	→(53)

(c) 12-character 2-line Display Example

The relation between DD RAM address and display position on the LCD is shown below:

	1	2	3	4	5	6	7	8	9	10	11	12	←Display Position
1st Line	00	01	02	03	04	05	06	07	08	09	0A	0B	←
2nd Line	40	41	42	43	44	45	46	47	48	49	4A	4B	← (Hexadecimal)

When the display shift is performed, the DD RAM address changes as follows:

(Left Shift Display)

(00)←	01	02	03	04	05	06	07	08	09	0A	0B	0C
(40)←	41	42	43	44	45	46	47	48	49	4A	4B	4C

(Right Shift Display)

27	00	01	02	03	04	05	06	07	08	09	0A	→(0B)
67	40	41	42	43	44	45	46	47	48	49	4A	→(4B)

(1-5) Character Generator ROM

The Character Generator ROM (CG ROM) generates 5 x 7 dots character pattern represented in 8-bit character codes.

The storage capacity is up to 240 kinds of 5 x 7 dots character pattern. The correspondence between character code and standard character pattern of NJU6406B is shown in Table 2-1 to 2-5.

User-defined character pattern (Custom Font) are also available by mask option.

Table 2-1. CG ROM Character Pattern (ROM version -00)

		Upper 4 bits (Hexadecimal)															
		0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
Lower 4 bits (Hexadecimal)	0	CG RAM (01)			0	0	P	`	P				—	9	3		
	1	(02)		!	1	A	0	a	4				7	7	4		
	2	(03)		"	2	B	R	b	r				7	イ	ウ	ノ	
	3	(04)		#	3	C	5	c	5				7	ウ	テ	E	
	4	(05)		\$	4	D	T	d	t				7	エ	ト	ト	
	5	(06)		%	5	E	U	e	u				7	オ	ナ	1	
	6	(07)		&	6	F	V	f	v				7	カ	ニ	ヨ	
	7	(08)		'	7	G	W	g	w				7	キ	ア	ラ	
	8	(01)		(	8	H	X	h	x				7	ク	ホ	リ	
	9	(02)		)	9	I	Y	i	y				7	ケ	ル		
	A	(03)		*	:	J	Z	j	z				7	コ	ハ	レ	
	B	(04)		+	:	K	E	k	e				7	サ	ヒ	ロ	
	C	(05)		,	<	L	*1	l	1				7	セ	フ	ワ	
	D	(06)		—	=	M	I	m	i				7	ズ	ハ	シ	
	E	(07)		.	>	N	^	n	+				7	セ	ホ	マ	
	F	(08)		/	?0	—	o	+					7	ワ	マ		

Table 2-2. CG ROM Character Pattern (ROM version -01)

		Upper 4 bits (Hexadecimal)															
		0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
Lower 4 bits (Hexadecimal)	0	CG RAM (01)			0	a	P	`	P				—	9	E	o	p
	1	(02)		!	1	A	Q	a	9			u	7	+	4	ä	q
	2	(03)		"	2	B	R	b	r			r	Y	W	X	æ	ø
	3	(04)		#	3	C	S	c	s			J	U	T	E	æ	æ
	4	(05)		\$	4	D	T	d	t			\	I	t	†	µ	o
	5	(06)		%	5	E	U	e	u			.	o	+	1	6	ü
	6	(07)		&	6	F	V	f	v			3	h	二	3	ρ	Σ
	7	(08)		'	7	G	W	g	w			7	+	7	7	9	π
	8	(01)		(	8	H	X	h	x			4	o	8	U	J	X
	9	(02)		)	9	I	Y	i	y			6	7	J	U	Y	y
	A	(03)		*	*	J	Z	j	z			±	コ	h	レ	j	7
	B	(04)		+	3	K	L	k	l			*	サ	ヒ	0	*	ア
	C	(05)		,	<	L	*	1	1			+	3	7	7	+	ア
	D	(06)		—	=	M	I	m	i			α	ズ	^	コ	レ	÷
	E	(07)		.	>	N	^	n	+			3	ヒ	サ	Y	ア	
	F	(08)		/	?	O	_	o	+			ウ	Y	マ	"	ö	■

Table 2-3. CG ROM Character Pattern (ROM version -02)

		Upper 4 bits (Hexadecimal)															
		0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
Lower 4 bits (Hexadecimal)	0	CG RAM (01)	A		0	a	P	`	F	Q	E		-	9	E	o	p
	1	(02)	B	!	1	A	Q	a	4	U	a	.	7	7	4	ä	q
	2	(03)	ä	"	2	B	R	b	r	e	E	"	イ	ウ	×	æ	θ
	3	(04)	1	#	3	C	S	c	s	ä	ö	,	ウ	7	ε	ε	ω
	4	(05)	ö	\$	4	D	T	d	t	ä	ö	,	エ	ト	†	µ	α
	5	(06)	ü	%	5	E	U	e	u	ä	ö	.	オ	†	1	ε	ü
	6	(07)	A	&	6	F	V	f	v	ä	ö	7	カ	二	3	ρ	Σ
	7	(08)	A	'	7	G	W	g	w	ç	ü	7	†	7	7	9	π
	8	(01)	ä	(	8	H	X	h	x	e	ü	4	ウ	本	リ	7	Σ
	9	(02)	ö	)	9	I	Y	i	y	è	ö	7	7	ル	7	7	9
	A	(03)	ç	*	:	J	Z	j	z	è	ü	エ	コ	ン	レ	j	7
	B	(04)	7	+	:	K	L	k	l	ç	ü	7	サ	ヒ	ロ	*	7
	C	(05)	7	,	<	L	#	1	1	i	é	7	7	7	7	7	7
	D	(06)	1	-	=	M	I	m	)	i	7	7	7	7	7	7	7
	E	(07)	ç	.	>	N	^	n	7	A	R	a	e	ホ	7	7	7
	F	(08)	7	/	7	O	_	o	7	A	7	7	7	7	7	7	7

Table 2-4. CG ROM Character Pattern (ROM version -03)

		Upper 4 bits (Hexadecimal)															
		0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
Lower 4 bits (Hexadecimal)	0	CG RAM (01)	±		0	0	P	'	P	5	e	a		r	W	B	t
	1	(02)	≡	!	1	A	0	a	9	0	×	i		J	+	y	U
	2	(03)	7	"	2	B	R	b	r	e	E	s	*	o	S	8	γ
	3	(04)	Λ	#	3	C	S	c	s	3	6	0	'	P	9	e	ψ
	4	(05)	/	\$	4	D	T	d	t	3	6	4	'	4	r	Z	o
	5	(06)	1	%	5	E	U	e	u	3	6	E	b	†	Δ	n	W
	6	(07)	Y	&	6	F	V	f	v	3	0	7	W	↓	θ	θ	≠
	7	(08)	J	'	7	G	W	g	w	5	0	R	X	+	Δ	L	≠
	8	(01)	r	(	8	H	X	h	x	e	9	†	÷	÷	3	K	W
	9	(02)	Y	)	9	I	Y	i	y	e	0	i	Δ	r	T	Λ	4
	A	(03)	×	*	:	J	Z	j	z	e	0	R	Z	7	Z	μ	P
	B	(04)	r	+	:	K	C	k	c	i	R	3	×	L	T	v	≠
	C	(05)	=	,	<	L	\	l	l	i	R	0	×	J	3	Z	0
	D	(06)	~	-	=	M	J	m	j	i	3	6	*	.	ψ	π	-
	E	(07)	3	.	>	N	^	n	^	A	0	0	J	0	0	0	0
	F	(08)	3	/	?	0	_	o	Δ	A	0	0	0	0	α	σ	0

Table 2-5. CG ROM Character Pattern (ROM version -A3)

		Upper 4 bits (Hexadecimal)															
		0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
Lower 4 bits (Hexadecimal)	0	CG RAM (01)	▀		0	a	P	'	P	À	É	Á	À	ñ	ó	ó	É
	1	(02)	▀	!	1	Q	a	a	u	é	i	À	·	·	·	·	±
	2	(03)	▀	"	2	B	R	b	r	é	É	ó	À	·	·	·	±
	3	(04)	▀	#	3	C	S	c	s	À	ó	ó	·	·	·	·	±
	4	(05)	▀	\$	4	D	T	d	t	À	ó	À	·	·	·	·	±
	5	(06)	▀	%	5	E	U	e	u	À	ó	À	·	·	·	·	±
	6	(07)	▀	&	6	F	V	f	v	À	ó	·	·	·	·	·	±
	7	(08)	▀	'	7	B	U	u	U	ó	·	·	·	·	·	·	±
	8	(01)	▀	(	8	H	X	h	x	ó	ó	·	·	·	·	·	±
	9	(02)	▀	)	9	I	Y	i	y	ó	ó	·	·	·	·	·	±
	A	(03)	▀	*	:	J	Z	j	z	ó	ó	·	·	·	·	·	±
	B	(04)	▀	+	:	K	L	k	l	ó	ó	·	·	·	·	·	±
	C	(05)	▀	,	<	L	\	l	l	ó	ó	·	·	·	·	·	±
	D	(06)	▀	-	=	M	I	m	i	ó	ó	·	·	·	·	·	±
	E	(07)	▀	.	>	N	^	n	^	ó	ó	·	·	·	·	·	±
	F	(08)	▀	/	?	O	_	o	Δ	ó	ó	·	·	·	·	·	±

(1-6) Character Generator RAM (CG RAM)

The character generator RAM(CG RAM) can store any kinds of character pattern in 5 x 7 dots written by the user program to display user's original character pattern. The CG RAM can store 8 kind of character in 5 X 7 dots mode.

To display user's original character pattern stored in the CG RAM, the address data (00)_H - (07)_H or (08)_H - (0F)_H should be written to the DD RAM as shown in Table 2-1 to 2-5.

Table 3. shows the correspondence among the character pattern, CG RAM address and Data.

Unused memory area of the CG RAM can also be used as the general data memory area.

Table 3. Correspondence of CG RAM address, DD RAM character code and CG RAM character pattern (5 X 7 dots).

Character Code (DD RAM Data)	CG RAM Address	Character Pattern (CG RAM Data)
7 6 5 4 3 2 1 0 ←-----→ Upper bit Lower bit	5 4 3 2 1 0 ←-----→ Upper bit Lower bit	7 6 5 4 3 2 1 0 ←-----→ Upper bit Lower bit
0 0 0 0 * 0 0 0	0 0 0	*** 0 0 0 0 0 0 1 0 1 0 0 1 1 1 0 0 1 0 1 1 1 0 1 1 1 *** Character Pattern Example(1) ←Cursor Position
0 0 0 0 * 0 0 1	0 0 1	*** 0 0 0 0 0 0 1 0 1 0 0 1 1 1 0 0 1 0 1 1 1 0 1 1 1 *** Character Pattern Example(2) ←Cursor Position
0 0 0 0 * 1 1 1	1 1 1	*** 0 0 0 0 0 1 1 0 0 1 0 1 1 1 0 1 1 1 *** *** 0 0 0 0 0 1 1 0 0 1 0 1 1 1 0 1 1 1 ***

* : Don't Care

- Notes :
- Character code bits 0 to 2 correspond to the CG RAM address 3 to 5 (3 bits : 8 patterns).
 - CG RAM address 0, 1 and 2 designate character pattern line position. The 8th line is the cursor position and the display is performed by logical OR with cursor. Therefore, in case of the cursor display, the 8th line should be "0". If there is "1" in the 8th line, the bit "1" is always displayed on the cursor position regardless of cursor existence.
 - Character pattern row position correspond to the CG RAM data bits 0 to 4 are shown above. The bits 5 to 7 of the CG RAM are not appear on the display (no meaning for the display), but memory elements are existing, therefore it can be used as the general purpose RAM.
 - CG RAM character patterns are selected when character code bits 4 to 7 are all "0" and it is addressed by character code bits 0 to 2. Therefore, the address (00)_H and (08)_H, (01)_H and (09)_H, -----, (07)_H and (0F)_H select the same character pattern as shown in Table 2-1 to 2-5 and Table 3.
 - "1" for CG RAM data corresponds to display On and "0" to display Off.

(1-7) Timing Generator

The timing generator generates a timing signals for the DD RAM, CG RAM, CG ROM and other internal circuits operation.

RAM read timing for the display and internal operation timing for MPU access are separately generated, so that they may not interfere with each other.

Therefore, when the data write to the DD RAM for example, there will be no undesirable influence, such as flickering, in areas other than the display area.

(1-8) LCD Driver

LCD driver consist of 32-common driver and 60-segment driver.

When the line number is selected by a program, the required common drivers output the common driving waveform and the other common drivers output non-selection waveform automatically.

The 60 bits of character pattern data are shifted in the shift-register and latched when the 60 bits shift performed completely. This latched data controls display driver to output LCD driving waveform.

(1-9) Cursor Blinking Control Circuit

This circuits controls cursor On/Off and cursor position character blinks.

The cursor or blinks appear in the digit residing at the DD RAM address set in the address counter (AC).

When the address counter is (08)_H, a cursor position is shown as follows:

AC ₆ AC ₅ AC ₄ AC ₃ AC ₂ AC ₁ AC ₀							
0	0	0	1	0	0	0	0

1-line Display	1	2	3	4	5	6	7	8	9	10	11	12	
	00	01	02	03	04	05	06	07	08	09	0A	0B	----
	↑ Cursor position												

2-line Display	1	2	3	4	5	6	7	8	9	10	11	12	
	00	01	02	03	04	05	06	07	08	09	0A	0B	----
	40	41	42	43	44	45	46	47	48	49	4A	4B	----

	↑ Cursor position												
--	-------------------	--	--	--	--	--	--	--	--	--	--	--	--

← Display position													
← DD RAM address (Hexadecimal)													

← Display position													
← DD RAM address (Hexadecimal)													

(Note) The cursor or blinks appear when the address counter (AC) selects the CG RAM.

But the displayed the cursor and blink are meaningless.

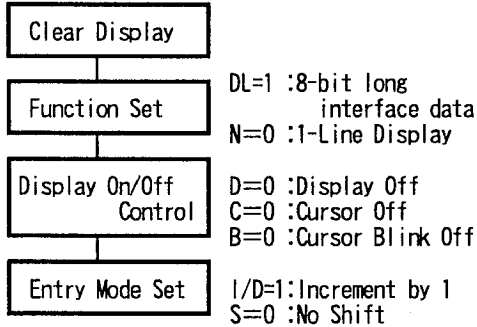
If the AC storing the CG RAM address data, the cursor and blink are displayed in the meaningless position.

(2) Power on Initialization by internal circuits

The NJU6406B is automatically initialized by internal power on initialization circuits when the power is turned on. In the internal power on initialization, following instructions are executed.

During the Internal power on initialization, the busy flag (BF) is "1" and this status is kept 10 ms after V_{DD} rises to 4.5V.

Initialization flow is shown below:



NOTE

If the condition of power supply rise time described in the Electrical Characteristics is not satisfied, the internal Power On Initialization Circuits will not operate and initialization will not be performed. In this case the initialization by MPU software is required.

(3) Instructions

The NJU6406B incorporates two registers, an Instruction Register (IR) and a Data Register (DR).

These two registers store control information temporarily to allow interface between NJU6406B and MPU or peripheral ICs operating different cycles. The operation of NJU6406B is determined by this control signal from MPU.

The control information includes register selection signals (RS), read/write signals (R/W) and data bus signals (DB_0 to DB_7).

Table 4. shows each instruction and its operating time.

Note) The execution time mentioned in Table 4. based on f_{cp} or $f_{osc}=250kHz$.

If the oscillation frequency is changed, the execution time is also changed.

Table 4. Table of Instructions

INSTRUCTIONS	RS	R/W	C DB ₇	O DB ₆	D DB ₅	E DB ₄	DB ₃	DB ₂	DB ₁	DB ₀	DESCRIPTION	EXEC TIME
Non-operation	0	0	0	0	0	0	0	0	0	0	Non-operation. Only takes judgement machine cycle.	40us
Clear Display	0	0	0	0	0	0	0	0	0	1	Display clear and sets DD RAM address 0 in AC.	1.64ms
Return Home	0	0	0	0	0	0	0	0	1	*	Sets DD RAM address 0 in AC and returns display being shifted to original position. DD RAM contents remain unchanged	1.64ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies shift of display are performed in data read/write. I/D=1:Increment, I/D=0:Decrement S=1:Accompanies display shift	40us
Display On/Off Control	0	0	0	0	0	0	1	D	C	B	Sets of display On/Off(D), cursor On/Off(C) and blink of cursor position character(B).	40us
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	*	*	Moves cursor and shifts display without changing DD RAM contents S/C=1 : Display shift S/C=0 : Cursor shift R/L=1 : Shift to the right R/L=0 : Shift to the left	60us
Function Set	0	0	0	0	1	DL	N	*	*	*	Sets interface data length(DL), number of display lines(N). DL=1 : 8 bits, DL=0 : 4 bits N=1 : 2 lines, N=0 : 1 line	40us
Set CG RAM Address	0	0	0	1	←---		A _{CG}		----		Sets CG RAM address. After this instruction, the data is transferred on CG RAM.	40us
Set DD RAM Address	0	0	1	←---		A _{DD}		----			Sets DD RAM address. After this instruction, the data is transferred on DD RAM.	40us
Read Busy Flag & Address	0	1	BF	←---		AC		----			Reads busy flag and AC contents. BF=1 : Internally operating BF=0 : Can accept instruction	0us
Write Data to CG & DD RAM	1	0	←---		Write Data		----				Writes data into DD or CG RAMs.	40us
Read Data from CG or DD RAM	1	1	←---		Read Data		----				Reads data from DD or CG RAMs.	60us
Explanation of Abbreviation	DD RAM : Display data RAM , CG RAM : Character generator RAM A _{CG} : CG RAM address, A _{DD} : DD RAM address, Corresponds to cursor address AC : Address counter used for both of DD and CG RAMs											

(3-1) Description of each instructions

(a) NOP (Non operation)

	RS	R/W	DB ₇	DB ₆	DB ₅	DB ₄	DB ₃	DB ₂	DB ₁	DB ₀
Code	0	0	0	0	0	0	0	0	0	0

Non operation instruction. It consumes certain judgement machine cycles only.

(b) Clear Display

	RS	R/W	DB ₇	DB ₆	DB ₅	DB ₄	DB ₃	DB ₂	DB ₁	DB ₀
Code	0	0	0	0	0	0	0	0	0	1

Clear display instruction is executed when the code "1" is written into DB₀. When this instruction is executed, the space code (20)_H is written into every DD RAM address, the DD RAM address 0 is set into the address counter and entry mode is set increment. If the cursor or blink are displayed, they are returned to the left end of the LCD(the left end of the 1st line in the 2-line display mode).

The S of entry mode does not change.

Note: The character pattern for character code (20)_H must be blank code in the user-defined character pattern(Custom font).

(c) Return Home

	RS	R/W	DB ₇	DB ₆	DB ₅	DB ₄	DB ₃	DB ₂	DB ₁	DB ₀
Code	0	0	0	0	0	0	0	0	1	*

* = Don't care

Return home instruction is executed when the code "1" is written into DB₁. When this instruction is executed, the DD RAM address 0 is set into the address counter. Display is returned its original position if shifted, the cursor or blink are returned to the left end of the LCD(the left end of the 1st line in the 2-line display mode) if the cursor or blink are on the display.

The DD RAM contents do not change.

(d) Entry Mode Set

	RS	R/W	DB ₇	DB ₆	DB ₅	DB ₄	DB ₃	DB ₂	DB ₁	DB ₀
Code	0	0	0	0	0	0	0	1	I/D	S

Entry mode set instruction which sets the cursor moving direction and display shift On/Off, is executed when the code "1" is written into DB₂ and the codes of (I/D) and (S) are written into DB₁(I/D) and DB₀(S), as shown below.

(I/D) sets the address increment or decrement, and the (S) sets the entire display shift in the DD RAM writing.

I/D	F u n c t i o n
1	Address increment: The address of the DD or CG RAM increment (+1) when the read/write, and the cursor or blink move to the right.
0	Address decrement: The address of the DD or CG RAM decrement (-1) when the read/write, and the cursor or blink move to the left.

S	F u n c t i o n
1	Entire display shift. The shift direction is determined by I/D: shift to the left at I/D=1 and shift to the right at the I/D=0. The shift is operated only for the character, so that it looks as if the cursor stands still and the display moves. The display does not shift when reading from the DD RAM and writing/reading into/from CG RAM.
0	The display does not shifting.

(e) Display On/Off Control

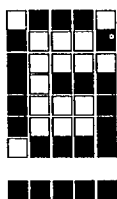
	RS	R/W	DB ₇	DB ₆	DB ₅	DB ₄	DB ₃	DB ₂	DB ₁	DB ₀
Code	0	0	0	0	0	0	1	D	C	B

Display On/Off control instruction which controls the display On/Off, the cursor On/Off and the cursor position character blink, is executed when the code "1" is written into DB₃ and the codes of (D), (C) and (B) are written into DB₂(D), DB₁(C) and DB₀(B), as shown below.

D	F u n c t i o n
1	Display On.
0	Display Off. In this mode, the display data remains in the DD RAM so that it is retrieved immediately on the display when the D change to 1.

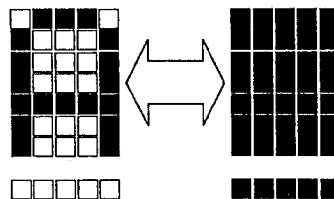
C	F u n c t i o n
1	Cursor On. The cursor is displayed by 5 dots on the 8th line.
0	Cursor Off. Even if the display data write, the I/D etc does not change.

B	F u n c t i o n
1	The cursor position character is blinking. Blinking rate is 455.2ms at f_{CP} or $f_{OSC}=270kHz$ and 491.6ms at $f_{CP}=250kHz$. The blink is displayed alternatively with all on (it means all black) and characters display. The cursor and the blink can be displayed simultaneously.
0	The character does not blink.



Character Font 5 x 7 dots

(1) Cursor display example



Alternating display

(2) Blink display example

(f) Cursor/Display Shift

	RS	R/W	DB ₇	DB ₆	DB ₅	DB ₄	DB ₃	DB ₂	DB ₁	DB ₀	
Code	0	0	0	0	0	1	S/C	R/L	*	*	* = Don't care

The Cursor/Display shift instruction shifts the cursor position or display to the right or left without writing or reading display data. This function is used to correct or search the display. In the 2-line display, the cursor moves to the 2nd line when it passes the 40th digit of the 1st line. Notice that the 1st and 2nd line displays will shift at the same time. When the displayed data is shifted repeatedly, each line moves only horizontally.

The 2nd line display does not shift into the 1st line position.

The contents of address counter(AC) does not change by operation of the display shift only.

This instruction is executed when the code "1" is written into DB₄ and the codes of (S/C) and (R/L) are written into DB₃(S/C) and DB₂(R/L), as shown below.

S/C	R/L	F u n c t i o n
0	0	Shifts the cursor position to the left ((AC) is decremented by 1)
0	1	Shifts the cursor position to the right ((AC) is incremented by 1)
1	0	Shifts the entire display to the left and the cursor follows it.
1	1	Shifts the entire display to the right and the cursor follows it.

(g) Function Set

	RS	R/W	DB ₇	DB ₆	DB ₅	DB ₄	DB ₃	DB ₂	DB ₁	DB ₀	
Code	0	0	0	0	1	DL	N	*	*	*	* = Don't care

Function set instruction which sets the interface data length and number of display lines, is executed when the code "1" is written into DB₅ and the codes of (DL) and (N) are written into DB₄(DL) and DB₃(N), as shown below (character font is fixed 5 X 7 dots).

(DL) sets the interface data length and (N) sets the number of display lines either the 1-line or 2-lines.

NOTE

This function set instruction must be performed at the head of the program prior to all other existing instructions(except Busy flag/Address read). This function set instruction can not be executed afterwards unless the interface data length change.

DL	F u n c t i o n
1	Set the interface data length to 8 bits (DB ₇ to DB ₀)
0	Set the interface data length to 4 bits (DB ₇ to DB ₄) The data must be sent or received twice.

N	Display lines	Character Font	Duty Ratio	N o t e
0	1	5 X 7 dots	1/16	
1	2	5 X 7 dots	1/32	

(h) Set CG RAM Address

	RS	R/W	DB ₇	DB ₆	DB ₅	DB ₄	DB ₃	DB ₂	DB ₁	DB ₀
Code	0	0	0	1	A	A	A	A	A	A
				←Higher order bit					Lower order bit	→

Set CG RAM address instruction is executed when the code "1" is written into DB₆ and the address is written into DB₅ to DB₀ as shown below.

The address data mentioned by binary code "AAAAAA" is written into the address counter(AC) together with the CG RAM addressing condition. After this instruction execution, the data writing/reading is performed into/from the CG RAM.

(i) Set DD RAM Address

	RS	R/W	DB ₇	DB ₆	DB ₅	DB ₄	DB ₃	DB ₂	DB ₁	DB ₀
Code	0	0	1	A	A	A	A	A	A	A
				←Higher order bit					Lower order bit	→

Set DD RAM address instruction is executed when the code "1" is written into DB₇ and the address is written into DB₆ to DB₀ as shown above.

The address data mentioned by binary code "AAAAAAA" is written into the address counter(AC) together with the DD RAM addressing condition. After this instruction, the data writing/reading is performed into/from the DD RAM.

Note : In case of the 1-line display, the address data is (00)_H to (4F)_H, and during the 2-line display, the address is (00)_H to (27)_H for the 1st line and (40)_H to (67)_H for the 2nd line.

(j) Read Busy Flag & Address

	RS	R/W	DB ₇	DB ₆	DB ₅	DB ₄	DB ₃	DB ₂	DB ₁	DB ₀
Code	0	1	BF	A	A	A	A	A	A	A
				←Higher order bit					Lower order bit	→

This instruction reads out the internal status of the NJU6406B. When this instruction is executed, the busy flag(BF) which indicate internal operation is read out from DB₇ and the address of CG RAM or DD RAM is read out from DB₆ to DB₀ (the address for CG RAM or DD RAM is determined by the previous instruction).

(BF)=1 indicates that internal operation is in progress. The next instruction is inhibited when (BF)=1. Check the (BF) status before the next write operation.

(k) Write Data to CG or DD RAM

	RS	R/W	DB ₇	DB ₆	DB ₅	DB ₄	DB ₃	DB ₂	DB ₁	DB ₀
Code	1	0	D	D	D	D	D	D	D	D
	←Higher order bit					Lower order bit→				

Write Data to CG RAM or DD RAM instruction is executed when the code "1" is written into (RS) and code "0" is written into (R/W).

By the execution of this instruction, the binary 8-bit data "DDDDDDDD" are written into the CG RAM or DD RAM. The selection of the CG RAM or DD RAM is determined by the previous instruction.

After this instruction execution, the address increment(+1) or decrement(-1) performed automatically according to the entry mode set. And the display shift is also executed according to the previous entry mode set.

(l) Read Data from CG or DD RAM

	RS	R/W	DB ₇	DB ₆	DB ₅	DB ₄	DB ₃	DB ₂	DB ₁	DB ₀
Code	1	1	D	D	D	D	D	D	D	D
	←Higher order bit					Lower order bit→				

Read Data from CG RAM or DD RAM instruction is executed when the code "1" is written into (RS) and (R/W).

By the execution of this instruction, the binary 8 bit data "DDDDDDDD" are read out from CG RAM or DD RAM. The selection of the CG RAM or DD RAM is determined by the previous instruction.

Before executing this instruction, either the CG RAM address set or DD RAM address set must be executed, otherwise the first read out data are invalidated.

When this instruction is serially executed, the next address data is normally read from the second read.

The address set instruction is not required if the cursor shift instruction is executed just beforehand(only DD RAM reading).

The cursor shift instruction has same function as the DD RAM address set, so that after reading the DD RAM, the address increment or decrement is executed automatically according to the entry mode.

But display shift does not occur regardless of the entry mode.

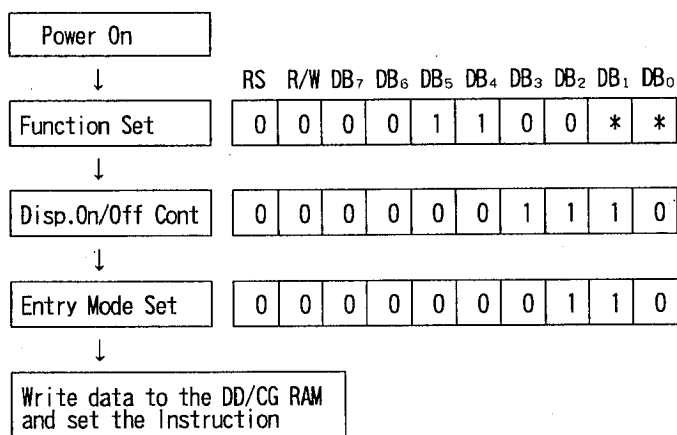
Note: The address counter(AC) is automatically incremented or decremented by 1 after write instructions to either of the CG RAM or DD RAM. Even if the read instruction is executed after this instruction, the addressed data can not be read out correctly. For a correct data read out, either the address set instruction or cursor shift instruction (only with DD RAM) must be implemented just before this instruction or from the second time read out instruction execution if the read out instruction is executed 2 times consecutively.

(3-2) Initialization using the internal reset circuits

(a) 24-character 1-line in 8-bit operation (Using internal reset circuits).

At the 24-character 1-line display, the Function set, Display On/Off Control and Entry Set Instruction must be executed before the data input, as shown below.

The DD RAM of the NJU6406B can store up to 80 characters, as explained before, therefore the advertising moving display is available when combined with display shift operation. Since the display shift operation changes only display position and the DD RAM contents remain unchanged, display data which are entered first can be output when the return home operation is performed.



Initialized.
No display appears.

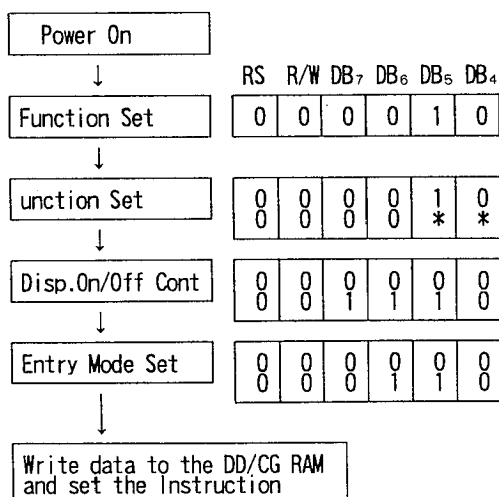
Set the 8-bit operation/
1-line display / 5X7dots
Font.

Turns on display and cursor. Entire display is in space mode by the initialization.
Example for set address increment and cursor right shift when the data write to the DD or CG RAM.

(b) 24-character 1-line in 4-bit operation (Using internal reset circuits).

In the 4-bit operation, the function set must be performed by the user programming.

When the power is turned on, 8-bit operation is selected automatically, therefore the first input is performed under 8-bit operation. In this operation, full instruction can not input because of terminals DB₀ to DB₃ are no connection. Therefore, same instruction must be rewritten on the RS, R/W and DB₇ to DB₄, as shown below. Since one operation is completed by the two accesses in the 4-bit operation mode, rewrite is required to set the instruction code in full. 24-character 1-line in 4-bit operation is shown as follows:



Initialized.
No display appears.

Set the 4-bit operation.
This step is executed in 8-bit mode set by the initialization.

Set the 4-bit operation / 1-line display / 5 X 7dots Font.
The 4-bit operation starts from this step.
Turn on display and cursor. Entire display is in space mode by the initialization.

Example for set address increment and cursor right shift when the data write to the DD or CG RAM.

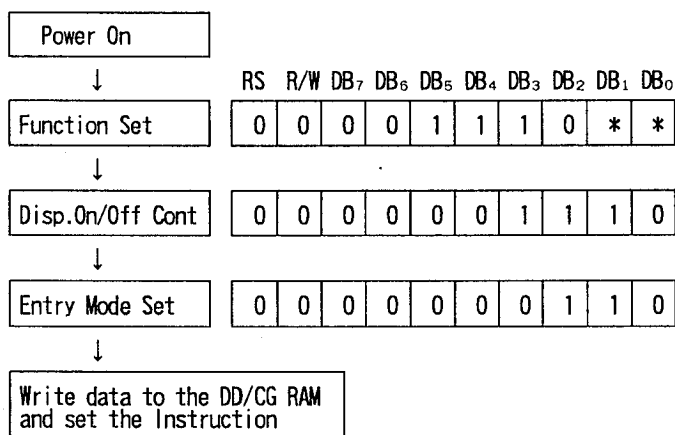
(c) 24-character 2-line in 8-bit operation (Using internal reset circuits).

In the 2-line display, the cursor moves automatically from the 1st to the 2nd line after the 40th character of the 1st line has been written.

Therefore, if the display characters is only 24 character in the 1st line, the DD RAM address must be set by the user programming to change the cursor position to the 2nd line.

The 1st and 2nd line displays will shift at the same time. When the displayed data is shifted repeatedly, each line moves only horizontally.

The 2nd line display does not shift into the 1st line position.



Initialized.
No display appears.

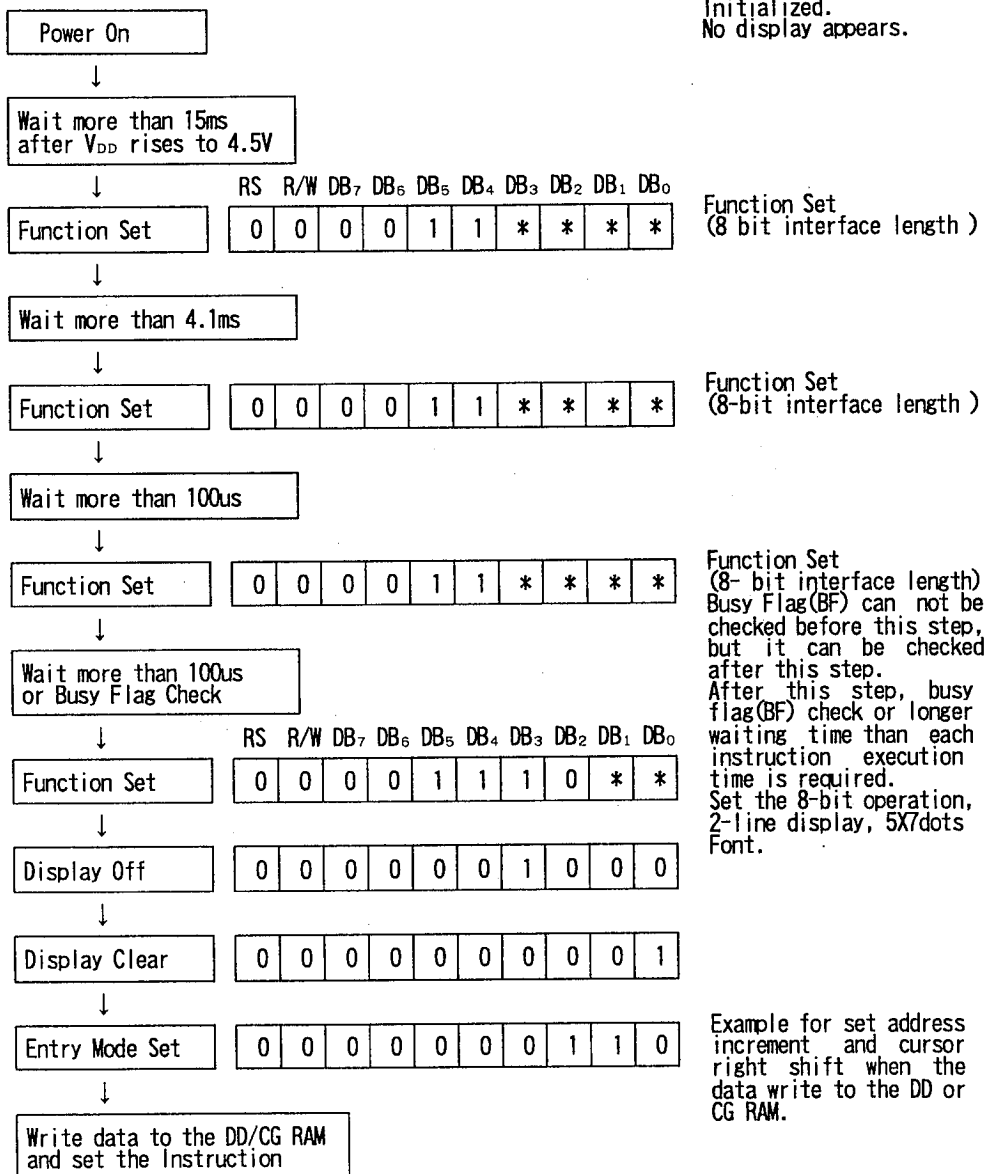
Set the 8-bit operation/
2-line display / 5X7dots
Font.

Turns on display and cursor. Entire display is in space mode by the initialization.
Example for set address increment and cursor right shift when the data write to the DD or CG RAM.

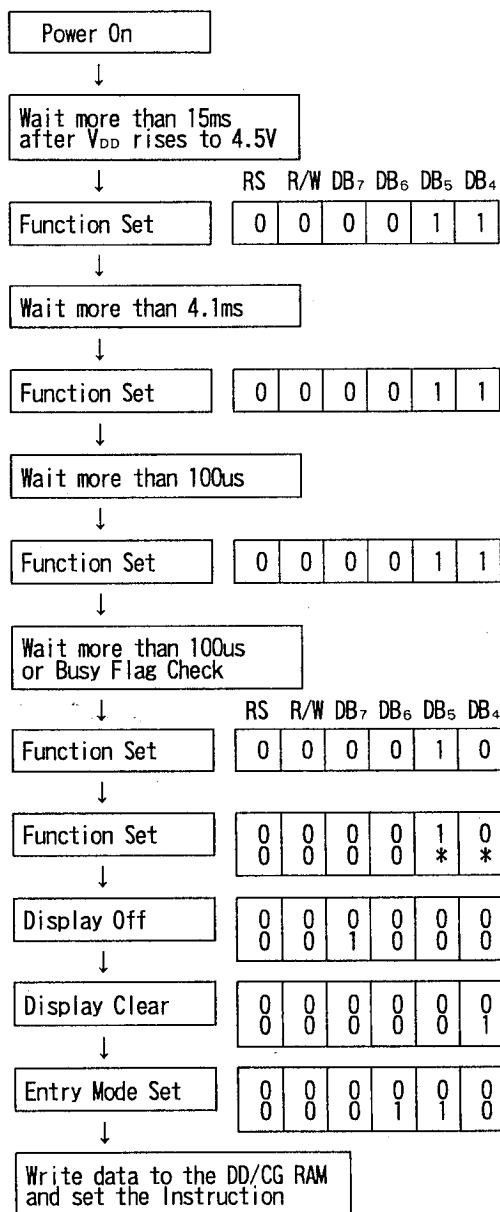
(3-3) Initialization by instruction

If the power supply conditions for the correct operation of the internal reset circuits are not met, the NJU6406B must be initialized by the instruction.

(a) Initialization by Instruction in 8-bit interface



(b) Initialization by Instruction in 4-bit interface



Initialized.
No display appears.

Function Set
(8-bit interface length)

Function Set
(8-bit interface length)

Function Set
(8-bit interface length)
Busy Flag(BF) can not be checked before this step, but it can be checked after this step.
After this step, busy flag (BF) check or longer waiting time than each instruction execution time is required.

Function Set in 8-bit interface length.
(Set 4-bit interface length)

Set the 4-bit operation/
1-line display 5X7dots Font.

Example for set address increment and cursor right shift when the data write to the DD or CG RAM.

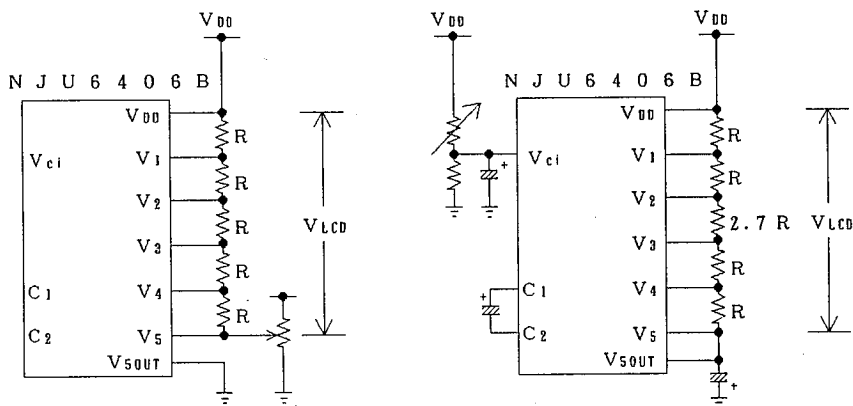
(4) LCD DISPLAY

(4-1) Power Supply for LCD Driving

NJU6406B incorporates voltage doubler to generate the LCD driving high voltage. The voltage doubler generate about twofold voltage from the V_{ci} input voltage (9.5V typ at $I_{out}=2mA$ and $V_{ci}=5V$). In order to generate LCD display driving waveform, the NJU6406B required external bleeder resistance. The bleeder resistance must be changed according to the duty ratio as shown below.

LCD Driving Voltage vs Duty Ratio

Power Supply	Duty Ratio	1/32	1/16
	Bias	1/6.7	1/5
	V_1	$V_{DD}-1/6.7V_{LCD}$	$V_{DD}-1/5V_{LCD}$
	V_2	$V_{DD}-2/6.7V_{LCD}$	$V_{DD}-2/5V_{LCD}$
	V_3	$V_{DD}-3/6.7V_{LCD}$	$V_{DD}-3/5V_{LCD}$
	V_4	$V_{DD}-4/6.7V_{LCD}$	$V_{DD}-4/5V_{LCD}$
	V_5	$V_{DD}-V_{LCD}$	$V_{DD}-V_{LCD}$



(a) 1/5 bias (1/16 Duty) (Internal Voltage Doubler No-use example) (b) 1/6.7 bias (1/32 Duty) (Internal Voltage Doubler using example)
Internal Driving Voltage Supply Examples

(4-2) Relation between oscillation frequency and LCD frame frequency.

The NJU6406B requires either one of the oscillation resistance(RF) or ceramic resonator for the internal oscillation, or external clock.

In case of the oscillation resistance using, the oscillating frequency is affected by the stray capacitance of the terminals OSC₁ and OSC₂, thus shorter connection length of these terminals are required.

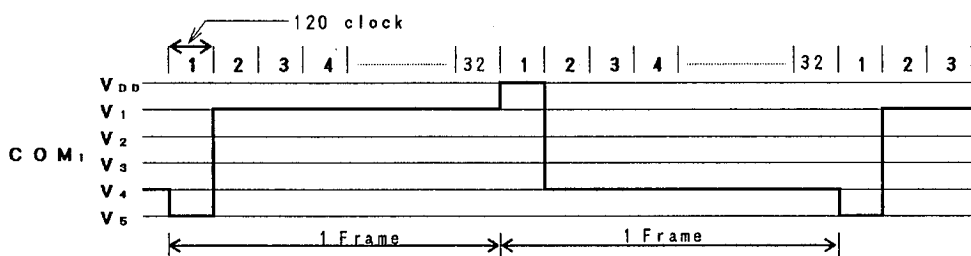
LCD frame frequency example mentioned below is based on 270kHz oscillation (1 clock = 3.7us).

LCD frame frequency is calculate by following formula.

$$1 \text{ frame cycle} = \frac{1}{f_{osc}} \times 120(\text{clock}) \times \text{the reciprocal number of duty}$$

$$1 \text{ frame frequency} = \frac{1}{1 \text{ frame cycle}}$$

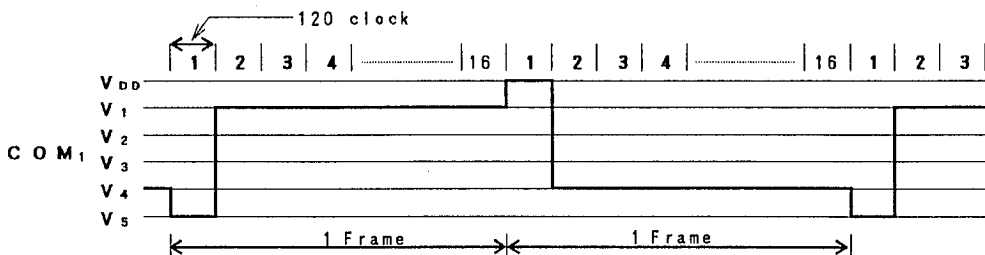
(a) 1/32 duty



$$1 \text{ frame} = 3.7(\mu\text{s}) \times 120 \times 32 = 14,208(\mu\text{s}) = 14.208(\text{ms})$$

$$\text{Frame frequency} = 1/14.208(\text{ms}) = 70.38(\text{Hz})$$

(b) 1/16 duty



$$1 \text{ frame} = 3.7(\mu\text{s}) \times 120 \times 16 = 7,104(\mu\text{s}) = 7.104(\text{ms})$$

$$\text{Frame frequency} = 1/7.104(\text{ms}) = 140.77(\text{Hz})$$

(5) Interface with MPU

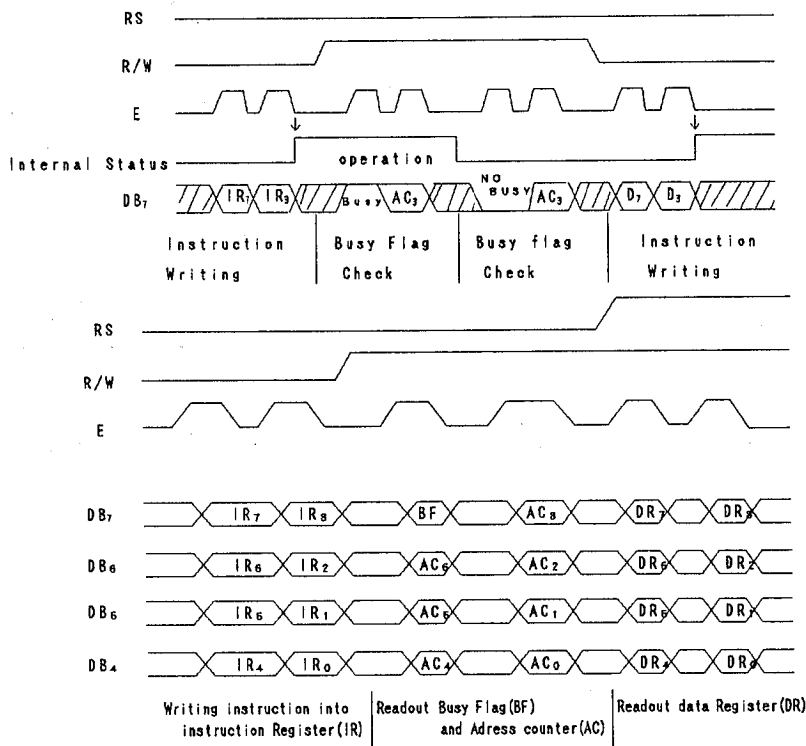
NJU6406B can be interfaced with both of 4/8 bit MPU and the two-time 4-bit or one-time 8-bit data transfer is available.

(5-1) 4-bit MPU interface

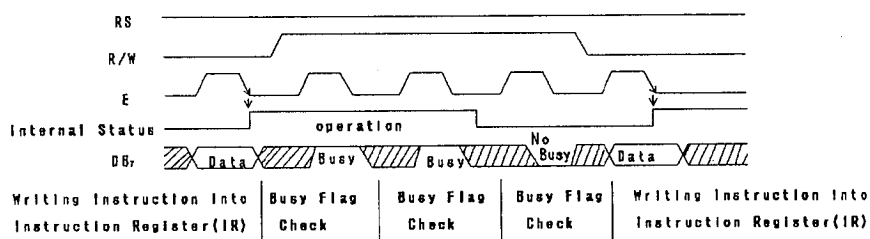
When the interface length is 4-bit, the data transfer is performed by 4 lines connected to DB₄ to DB₇ (DB₀ to DB₃ are not used). The data transfer with the MPU is completed by the two-time 4-bit data transfer.

The data transfer is executed in the sequence of upper 4-bit (the data DB₄ to DB₇ at 8-bit length) and lower 4-bit (the data DB₀ to DB₃ at 8-bit length).

The busy flag check must be executed after two-time 4-bit data transfer (1 instruction execution). In this case the data of busy flag and address counter are also output twice.



(5-2) 8-bit MPU interface



ABSOLUTE MAXIMUM RATINGS

(Ta=25°C)

PARAMETER	SYMBOL	RATINGS	UNIT
Supply Voltage (1)	V _{DD}	- 0.3 ~ + 7.0	V
Supply Voltage (2)	V _i ~V _s (3)	V _{DD} - 13.5~ V _{DD} +0.3	V
Input Voltage	V _{IN}	- 0.3 ~ V _{DD} +0.3	V
Operating Temperature	T _{opr}	- 30 ~ + 80	°C
Storage Temperature	T _{stg}	- 55 ~ + 125	°C

Note 1) If the LSI are used on condition above the absolute maximum ratings, the LSI may be destroyed. Using the LSI within electrical characteristics is strongly recommended for normal operation. Use beyond the electric characteristics conditions will cause malfunction and poor reliability.

Note 2) All voltage values are specified as V_{SS} = 0 V

Note 3) The relation : V_{DD} ≥ V_{ci} ≥ V_s ≥ V_{OUT}, V_{DD} ≥ V_{SS} ≥ V_{OUT}, V_{SS}=0V must be maintained.

Note 4) Decoupling capacitor should be connected between V_{ci} and V_{SS} due to the stabilized operation for the voltage doubler.

ELECTRICAL CHARACTERISTICS

(V_{DD}=5V±10%, V_{SS}=0V, Ta=-20 ~ +75°C)

PARAMETER		SYMBOL	CONDITIONS		MIN	TYP	MAX	UNIT	
Operating Voltage		V _{DD}			4.5	5.0	5.5	V	
Input Voltage	1	V _{IH1}	All Input and Input/Output Terminals except OSC Terminals		2.3		V _{DD}	V	5
		V _{IL1}				0.8			
	2	V _{IH2}	Only OSC Terminal		V _{DD} -1		V _{DD}	V	
		V _{IL2}				1.0			
Output Voltage	1	V _{OH1}	Input/Output Terminals	-I _{OH} =0.205mA	2.4			V	
		V _{OL1}		I _{OL} =1.6mA		0.4			
	2	V _{OH2}	Output Terminals	-I _{OH} =0.04mA	0.9V _{DD}			V	
		V _{OL2}		I _{OL} =0.04mA		0.1V _{DD}			
Driver On-resist.(COM)		R _{COM}	±I _D =0.05mA(All com.term.)				20	kΩ	6
Driver On-resist.(SEG)		R _{SEG}	±I _D =0.05mA(All seg.term.)				30		
Input Leakage Current		I _{LI}	V _{IN} =0 ~ V _{DD}		- 1		1	uA	7
Pull-up Resist Current		-I _P	V _{DD} =5V, RS, R/W, DB		50	125	250		
Operating Current (1)		I _{DD1}	Ceramic resonator V _{DD} =5V, f _{OSC} =250kHz			0.55	0.8	mA	
Operating Current (2)		I _{DD2}	CR Oscillation External-clock Operation V _{DD} =5V, f _{OSC} =f _{CP} =270kHz			0.6	1.0	mA	8
Voltage Doubler	Output Voltage	V _{Sout}	I _{OUT} =5mA, Ta=25°C		-2.8	-3.9		V	9
			I _{OUT} =1mA, Ta=25°C		-4.5	-4.7			
	Conversion Efficiency	V _{EF}	R _L =∞		95	99.9		%	
	Input Voltage	V _{ci}			2.5		5.5	V	
Ext. Clk	Operating Freq.	f _{cp}			125	250	350	kHz	
	Duty	DUTY			45	50	55	%	
	Rise Time	tr _{cp}					0.2	μs	
	Fall Time	tf _{cp}					0.2		
Int. OSC	Oscillation Frequency	f _{osc}	RF Osc. RF=91kΩ±2%		190	270	350	kHz	10
			Ceramic resonator			250		kHz	
LCD Driving Voltage		V _{LCD}	V _{DD} - V ₅	1/5 Bias 1/6.7 Bias	V _{DD} -3.0		V _{DD} -13.5	V	11

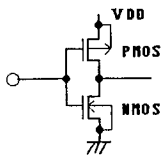
ELECTRICAL CHARACTERISTICS

($V_{DD}=2.4V\sim 3.6V$, $V_{SS}=0V$, $T_a=-20\sim +75^{\circ}C$)

PARAMETER		SYMBOL	CONDITIONS		MIN	TYP	MAX	UNIT	
Operating Voltage		V _{DD}			2.4	3.0	3.6	V	
Input Voltage		V _{IH1}	All Input and Input/Output Terminals		0.8V _{DD}		V _{DD}	V	5
		V _{IL1}				0.2V _{DD}			
Output Voltage	1	V _{OH1}	Input/Output Terminals	-I _{OH} =0.205mA -I _{OL} =1.6mA	2.0			V	
		V _{OL1}				0.5			
	2	V _{OH2}	Output Terminals	-I _{OH} =0.04mA -I _{OL} =0.04mA	0.9V _{DD}				
		V _{OL2}				0.1V _{DD}			
Driver On-resist.(COM)		R _{COM}	±I _D =0.05mA(All com.term.)				20	kΩ	6
Driver On-resist.(SEG)		R _{SEG}	±I _D =0.05mA(All seg.term.)				30		
Input Leakage Current		I _{LI}	V _{IN} =0 ~ V _{DD}		-1		1	μA	7
Pull-up Resist Current		-I _P	V _{DD} =3V		10	25	50		
Operating Current		I _{DD}	CR Oscillation External-clock Operation V _{DD} =3V, f _{OSC} =f _{CP} =240kHz			0.2	0.3	mA	8
Voltage Doubler	Output Voltage	V _{Sout}	V _{ci} =3V, I _{OUT} =1mA, Ta=25°C		-2.5	-2.75		V	9
	Conversion Efficiency	V _{EF}	R _L =∞		95	99.9		%	
	Input Voltage	V _{ci}			1.8		V _{DD}	V	
Int. OSC	Oscillation Frequency	fosc	RF Osc. RF=91kΩ±2%		160	240	320	kHz	10
LCD Driving Voltage		V _{LCD}	V _{DD} =3V, V _S Terminal		V _{DD} -3.0		V _{DD} -12.0	V	11

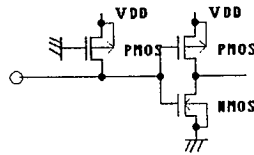
Note 5) Input/Output structure except LCD driver are shown below:

Input Terminal Structure



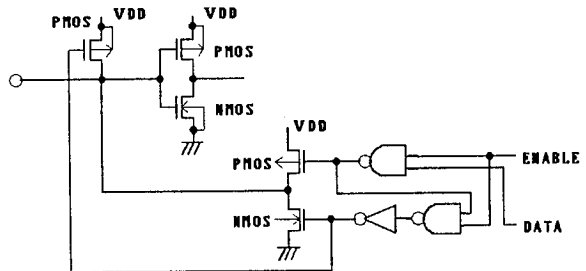
E Terminal

RS,R/W Terminals



RS,R/W Terminals

Input/Output Terminal Structure



DB₀ to DB₇ Terminals

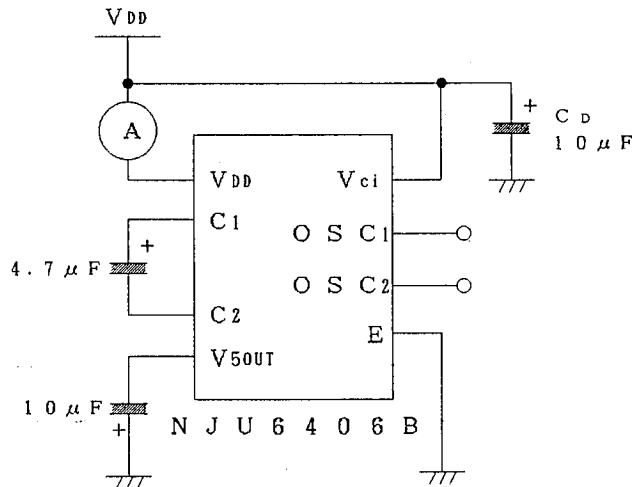
Note 6) R_{COM} and R_{SEG} are the resistance values between power supply terminals (V_{DD} , V_1 , V_4 , V_5) and each common terminal (COM_1 to COM_{32}), and supply voltage (V_{DD} , V_2 , V_3 , V_5) and each segment terminal (SEG_1 to SEG_{60}) respectively, and measured when the current I_d is flown on every common and segment terminals at a same time.

Note 7) Except pull-up resistance current and output driver current.

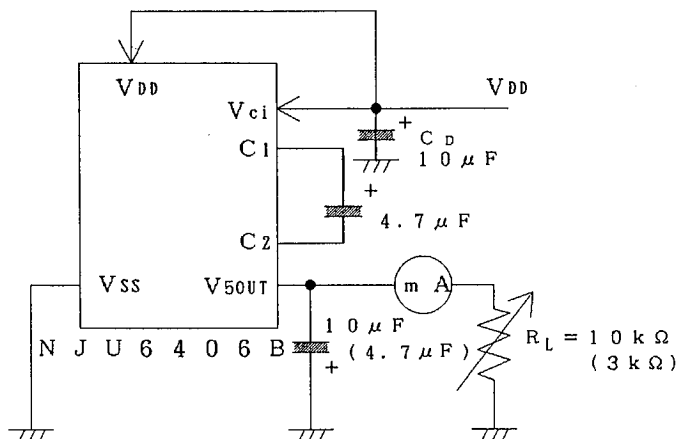
Note 8) Except input/output current.

If the input level is medium, current consumption will increase due to the penetration current. Therefore, the input level must be fixed to "H" or "L".

Operating Current Measuring Circuit

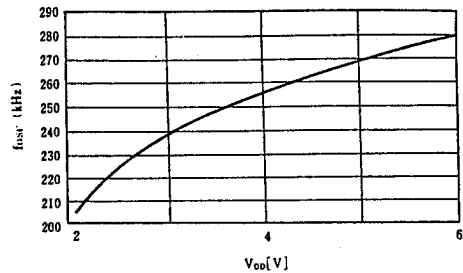
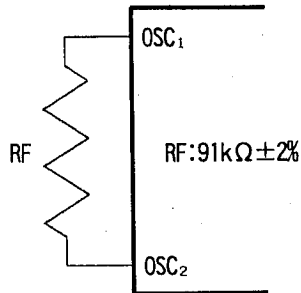


Note 9) Voltage Doubler Characteristics Measuring Circuit.



Note 10) Apply to internal CR oscillation using a oscillation resistance Rf.

As the oscillating frequency is affected by the stray capacitance of the terminals OSC₁ and OSC₂, shorter connection length of these terminals are required.



Note) As this circuit example mentioned only for standard application, it can not guaranty the characteristics of oscillation.
Please check the external parts value before production.

Note 11) Apply to the output voltage from each COM and SEG are less than $\pm 0.15V$ against the LCD driving constant voltage (V_{DD} , V_1 , V_2 , V_3 , V_4 , V_5) at no load condition.

Bus timing characteristics

Write operation sequence (Write from MPU to NJU6406B)

($V_{DD} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$)

PARAMETER	SYMBOL	MIN	MAX	CONDITION	UNIT
Enable Cycle Time	t_{CYCE}	500		fig.1	ns
Enable Pulse Width "High" level	P_{WEH}	220			
Enable Rise Time, Fall Time	t_{Er}, t_{Ef}		20		
Set up Time RS, R/W, E	t_{AS}	40			
Address Hold Time	t_{AH}	10			
Data Set up Time	t_{DSW}	60			
Data Hold Time	t_H	10			

Write operation sequence (Write from MPU to NJU6406B)

($V_{DD} = 3.0V \pm 20\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$)

PARAMETER	SYMBOL	MIN	MAX	CONDITION	UNIT
Enable Cycle Time	t_{CYCE}	1.4		fig.1	μs
Enable Pulse Width "High" level	P_{WEH}	500			ns
Enable Rise Time, Fall Time	t_{Er}, t_{Ef}		20		
Set up Time RS, R/W, E	t_{AS}	70			
Address Hold Time	t_{AH}	10			
Data Set up Time	t_{DSW}	140			
Data Hold Time	t_H	10			

Timing Characteristics (Write operation)

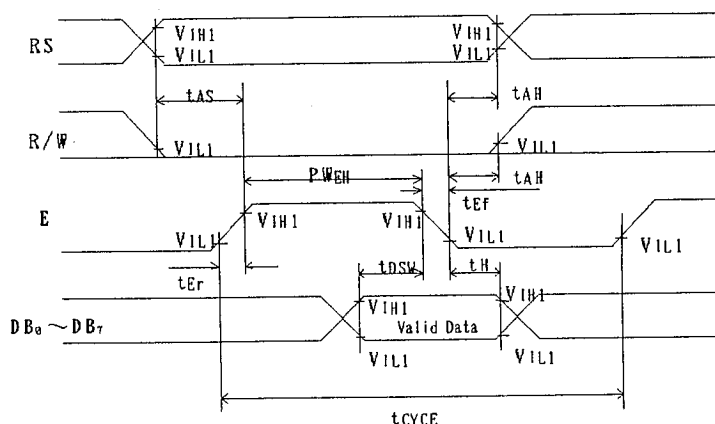


fig. 1 The timing characteristics of the bus write operating sequence.
(Write from MPU to NJU6406B)

Read operation sequence (Read from NJU6406B to MPU)

($V_{DD} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$)

P A R A M E T E R	SYMBOL	MIN	MAX	CONDITION	UNIT
Enable Cycle Time	t_{CYCE}	500		fig.2	ns
Enable Pulse Width "High" level	P_{WEH}	220			
Enable Rise Time, Fall Time	t_{Er}, t_{Ef}		20		
Set up Time RS, R/W, E	t_{AS}	40			
Address Hold Time	t_{AH}	10			
Data Delay Time	t_{DDW}		120		
Data Hold Time	t_{DDH}	20			

Read operation sequence (Read from NJU6406B to MPU)

($V_{DD} = 3.0V \pm 20\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$)

P A R A M E T E R	SYMBOL	MIN	MAX	CONDITION	UNIT
Enable Cycle Time	t_{CYCE}	1.4		fig.2	μs
Enable Pulse Width "High" level	P_{WEH}	500			ns
Enable Rise Time, Fall Time	t_{Er}, t_{Ef}		20		
Set up Time RS, R/W, E	t_{AS}	70			
Address Hold Time	t_{AH}	10			
Data Delay Time	t_{DDW}		600		
Data Hold Time	t_{DDH}	20			

Load condition of DB_0 to DB_7 : $C_L = 100pF$

Timing Characteristics (Read operation)

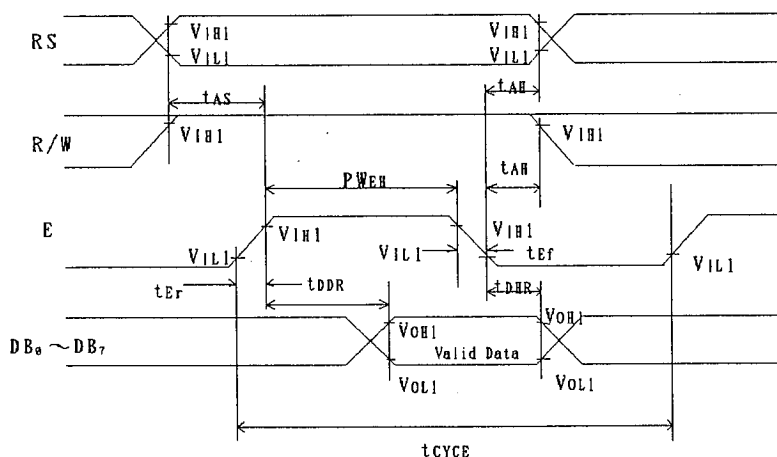


fig. 2 The timing characteristics of the bus read operating sequence.
(Read from NJU6406B to MPU)

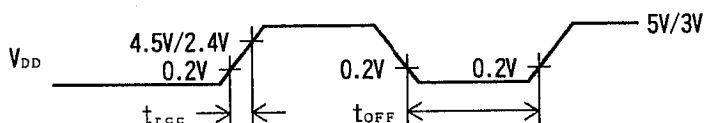
· Power Supply Condition when using the internal initialization circuit
($V_{DD} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$)

PARAMETER	SYMBOL	MIN	TYP	MAX	CONDITION	UNIT
Power Supply Rise Time	t_{rcc}	0.1	—	10		ms
Power Supply OFF Time	t_{off}	1	—			

· Power Supply Condition when using the internal initialization circuit
($V_{DD} = 3.0V \pm 20\%$, $V_{SS} = 0V$, $T_a = -20 \sim +75^\circ C$)

PARAMETER	SYMBOL	MIN	TYP	MAX	CONDITION	UNIT
Power Supply Rise Time	t_{rcc}	0.1	—	5		ms
Power Supply OFF Time	t_{off}	1	—			

Since the internal initialization circuits will not operate normally unless the above conditions are met, in such a case it must initialize by instruction.
(Refer to initialization by the instruction)



$V_{DD}=5V$ ---- $0.1ms \leq t_{rcc} \leq 10ms$

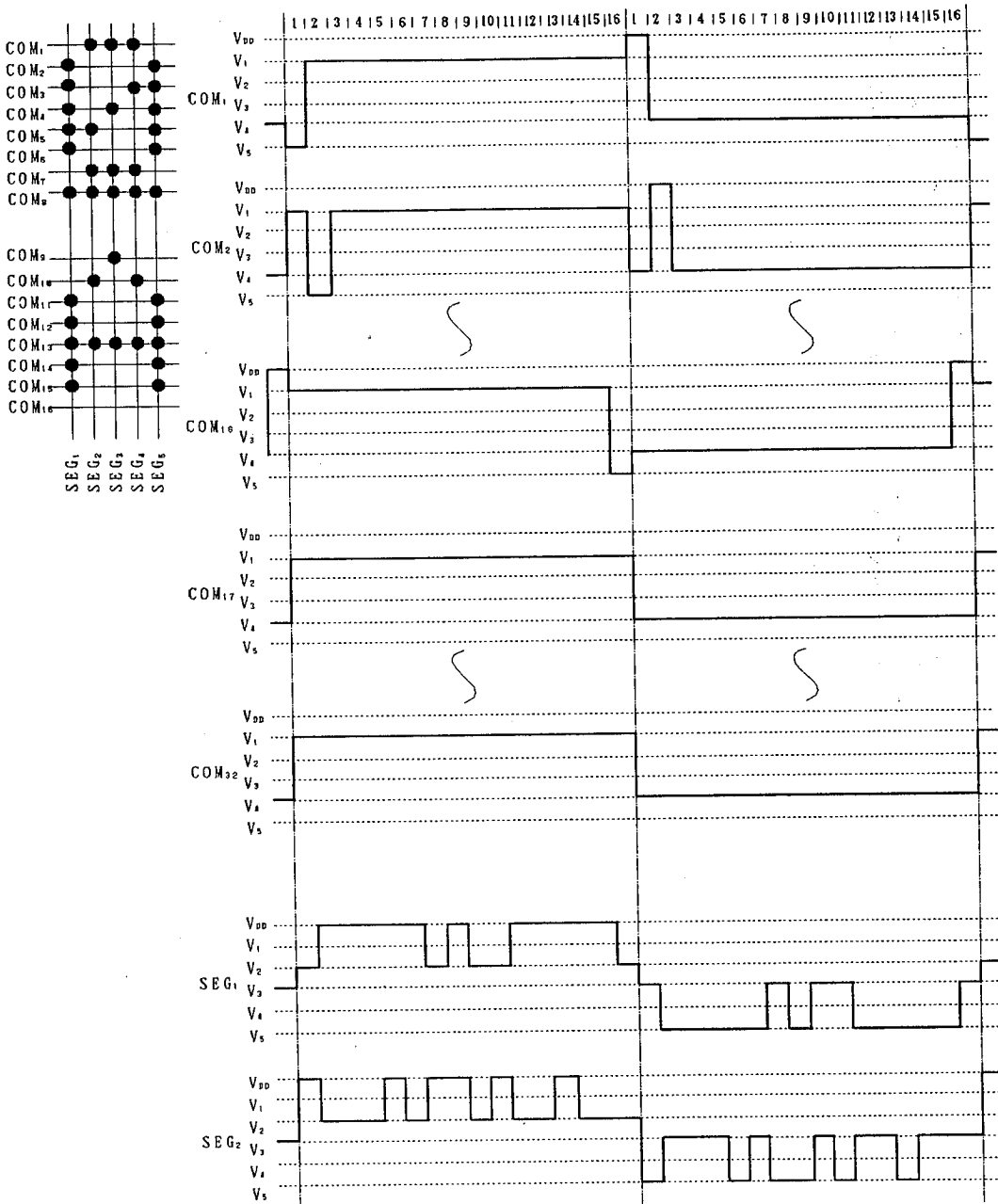
$t_{off} \geq 1ms$

$V_{DD}=3V$ ---- $0.1ms \leq t_{rcc} \leq 5ms$

t_{off} specifies power off time in a short period off or cyclical on/off.

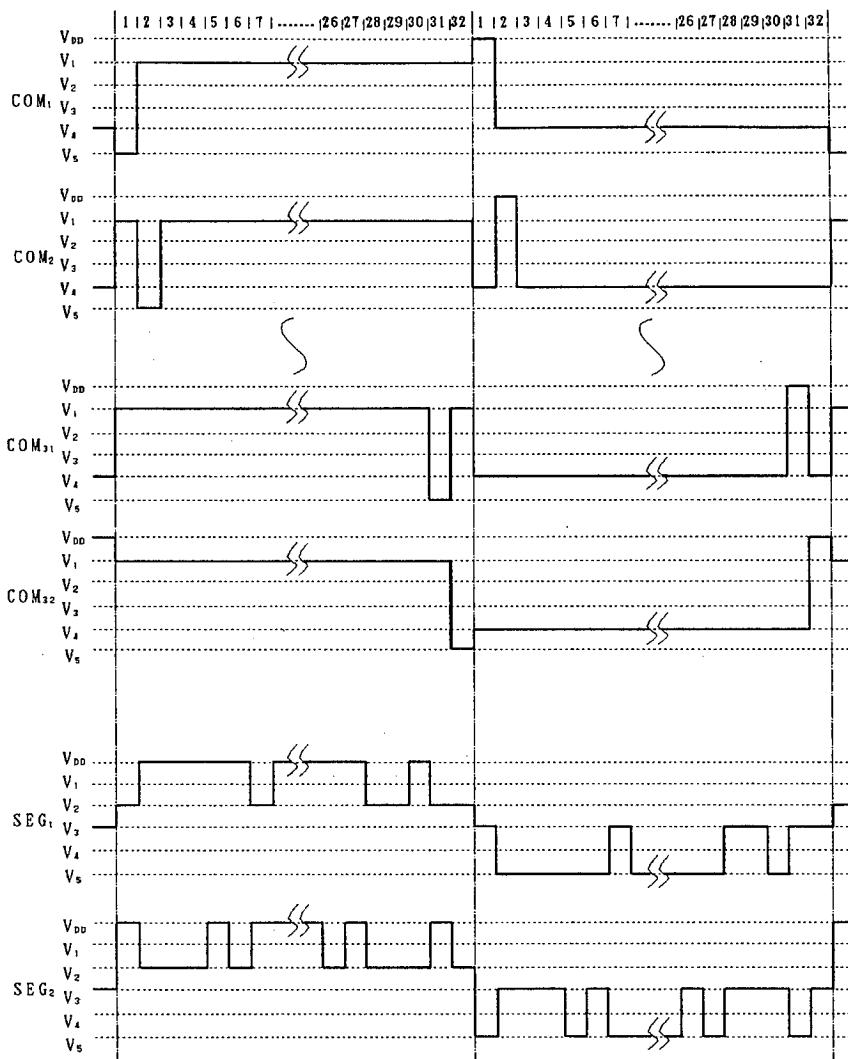
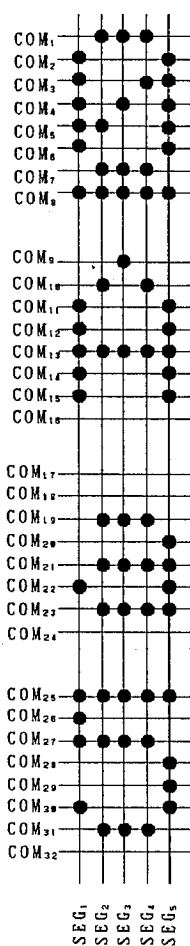
LCD DRIVING WAVEFORM

1/16 Duty Driving

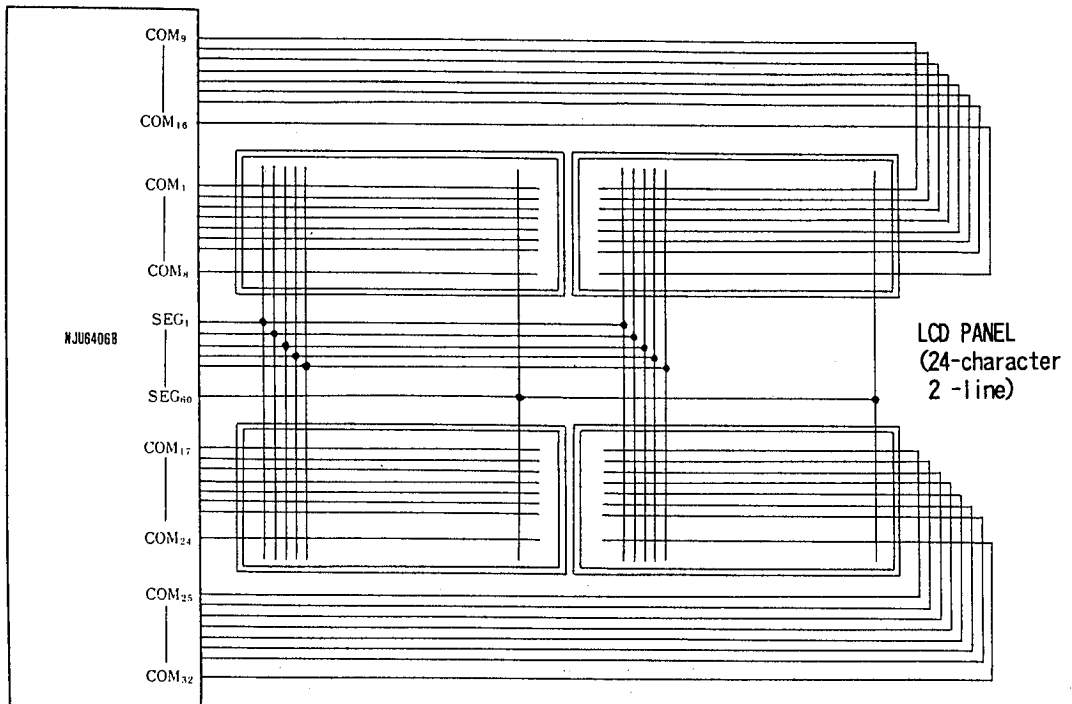


LCD DRIVING WAVEFORM

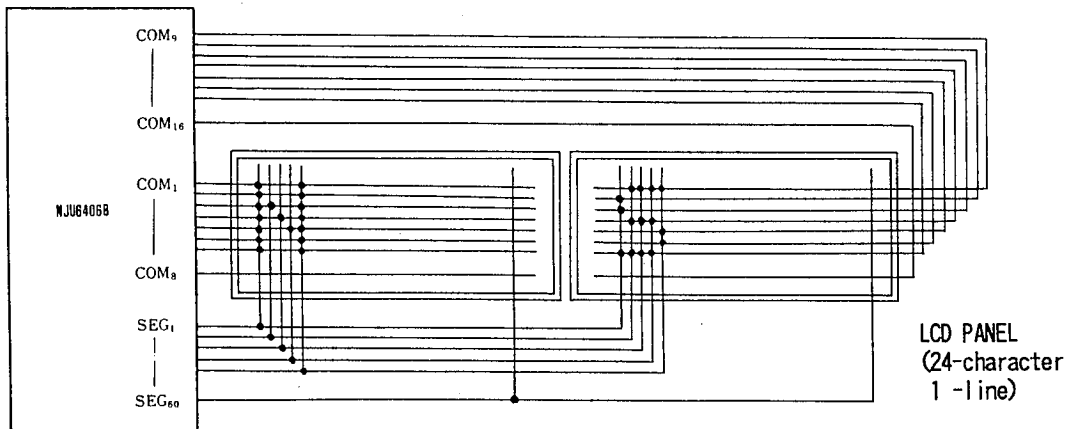
1/32 Duty Driving



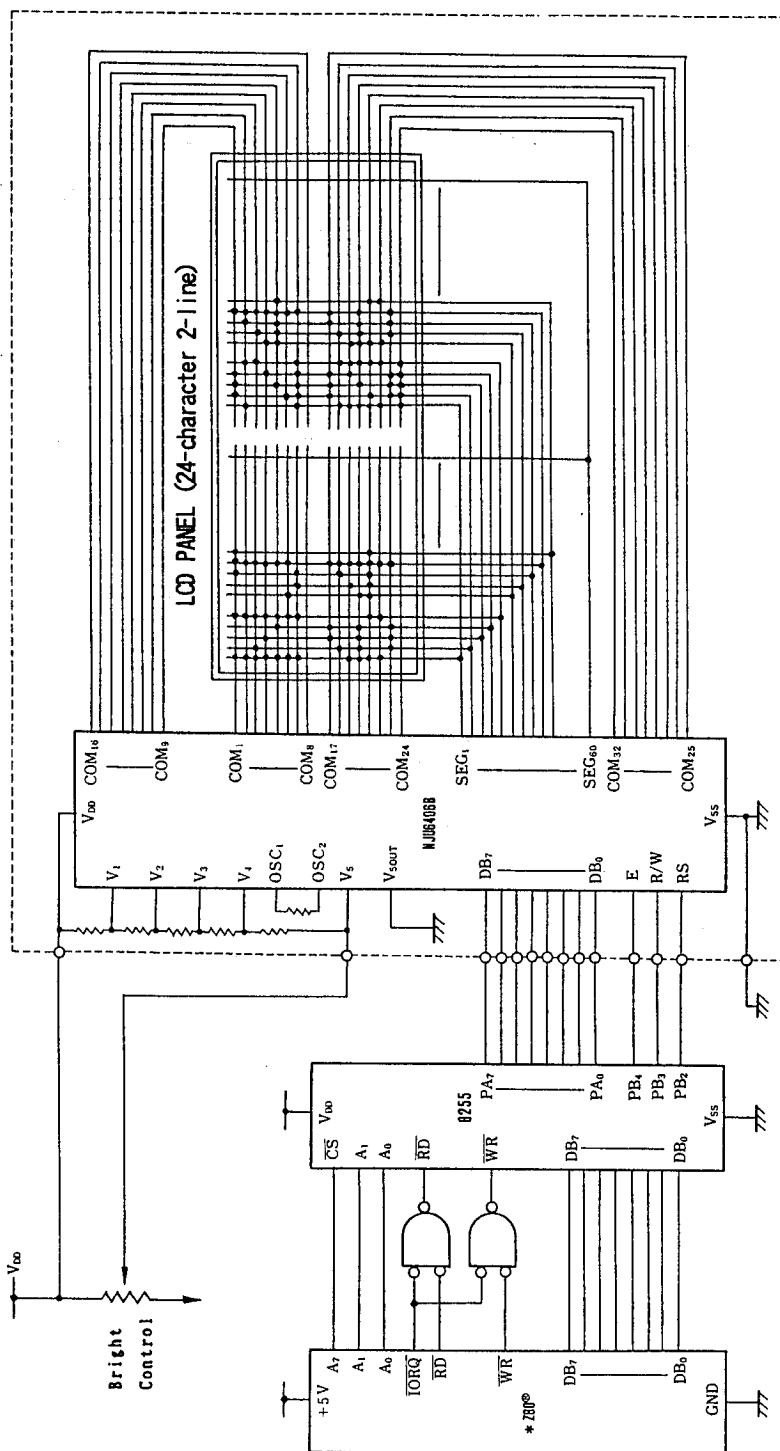
APPLICATION CIRCUITS



(a) 5 x 7 dots, 24-character 2-line example (1/6.7 Bias, 1/32 Duty)

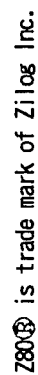


(b) 5 x 7 dots, 24-character 1-line example (1/5 Bias, 1/16 Duty)



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(c) 8-bit MPU interface example
(LCD driving voltage is supplied from external power supply)



(d) 8-bit MPU interface example
(Single power supply operation, LCD driving voltage is generated by NJU6406B)

MEMO

[CAUTION]

The specifications on this databook are only given for information, without any guarantee as regards either mistakes or omissions. The application circuits in this databook are described only to show representative usages of the product and not intended for the guarantee or permission of any right including the industrial rights.